

Silicon N Channel MOS FET

REJ03G0935-0200

(Previous: ADE-208-1275)

Rev.2.00 Sep 07, 2005

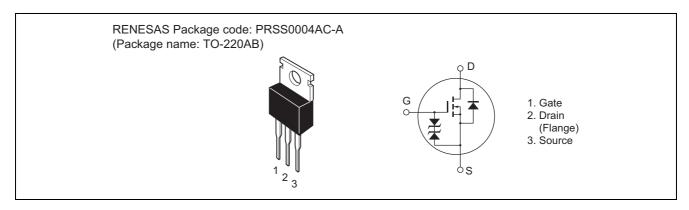
Application

High speed power switching

Features

- Low on-resistance
- High speed switching
- Low drive current
- No secondary breakdown
- Suitable for switching regulator and DC-DC converter

Outline



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 $(Ta = 25^{\circ}C)$

Item	Symbol	Ratings	Unit
Drain to source voltage	V_{DSS}	900	V
Gate to source voltage	V _{GSS}	±30	V
Drain current	I _D	2	А
Drain peak current	I _{D(pulse)} *1	6	А
Body to drain diode reverse drain current	I _{DR}	2	А
Channel dissipation	Pch _{*2}	50	W
Channel temperature	Tch	150	°C
Storage temperature	Tstg	-55 to +150	°C

Notes: 1. PW \leq 10 μ s, duty cycle \leq 1%

2. Value at $T_C = 25^{\circ}C$

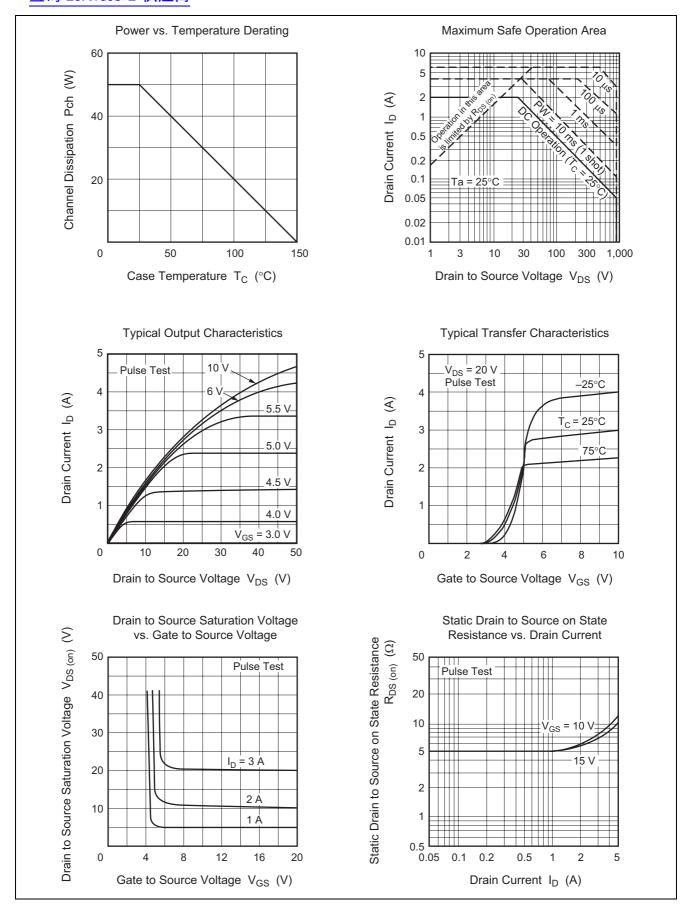
Electrical Characteristics

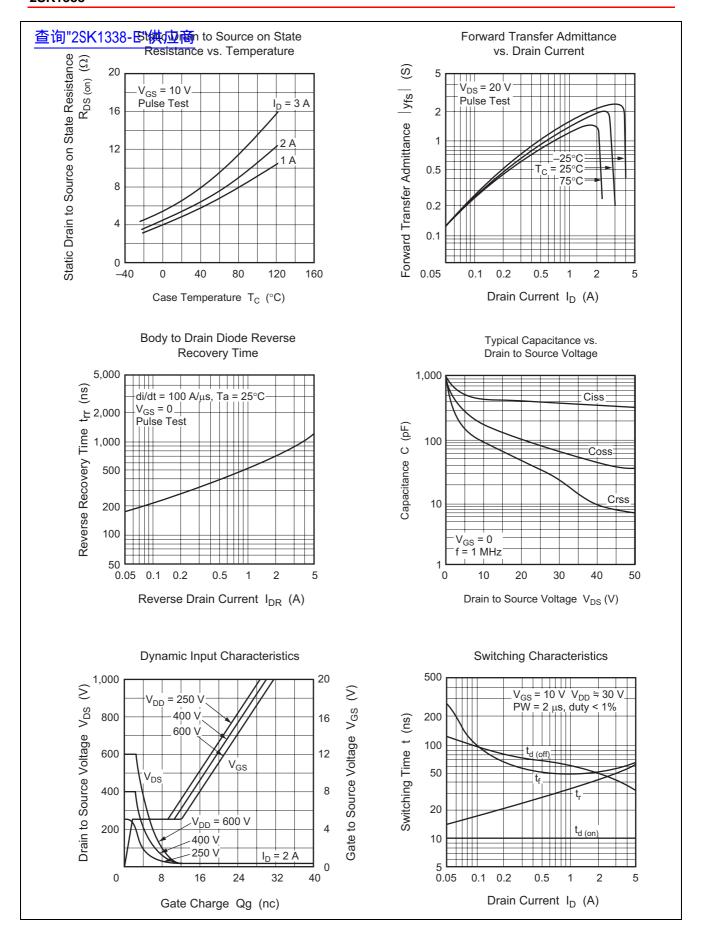
 $(Ta = 25^{\circ}C)$

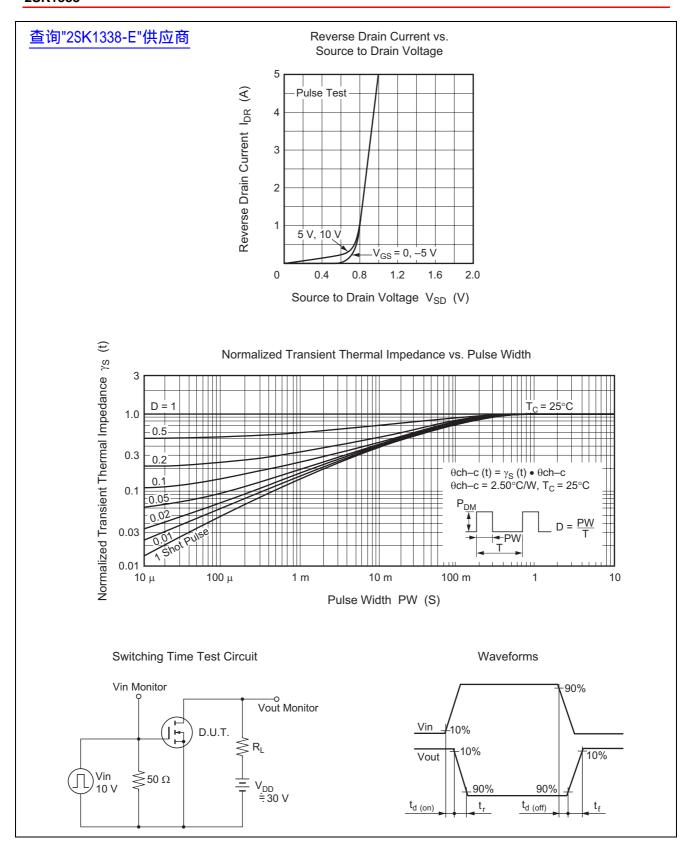
Item	Symbol	Min	Тур	Max	Unit	Test conditions
Drain to Source breakdown voltage	V _{(BR)DSS}	900	_	_	V	$I_D = 10 \text{ mA}, V_{GS} = 0$
Gate to Source breakdown voltage	V _{(BR)GSS}	±30	_	_	V	$I_G = \pm 100 \mu\text{A}, V_{DS} = 0$
Gate to Source leak current	I _{GSS}	_	_	±10	μΑ	$V_{GS} = \pm 25 \text{ V}, V_{DS} = 0$
Zero Gate voltage Drain current	I _{DSS}	_	_	250	μΑ	V _{DS} = 720 V, V _{GS} = 0
Gate to Source cutoff voltage	$V_{GS(off)}$	2.0	_	3.0	V	$I_D = 1 \text{ mA}, V_{DS} = 10 \text{ V}$
Static Drain to Source on state resistance	R _{DS(on)}	_	5.0	7.0	Ω	I _D = 1 A, V _{GS} = 10 V * ³
Forward transfer admittance	yfs	0.9	1.5	_	S	$I_D = 1 \text{ A}, V_{DS} = 20 \text{ V}^{*3}$
Input capacitance	Ciss		425	_	pF	$V_{DS} = 10 \text{ V}, V_{GS} = 0,$
Output capacitance	Coss		175	_	pF	f = 1 MHz
Reverse transfer capacitance	Crss		85	_	pF]
Turn-on delay time	t _{d(on)}	_	10	_	ns	$I_D = 1 \text{ A}, V_{GS} = 10 \text{ V},$
Rise time	t _r	_	35	_	ns	$R_L = 30 \Omega$
Turn-off delay time	t _{d(off)}	_	60	_	ns	
Fall time	t _f	_	50	_	ns	
Body to Drain diode forward voltage	V_{DF}	_	0.9	_	V	I _F = 2 A, V _{GS} = 0
Body to Drain diode reverse recovery time	t _{rr}	_	700	_	ns	$I_F = 2 \text{ A}, V_{GS} = 0,$ $di_F/dt = 100 \text{ A}/\mu\text{s}$

Note: 3. Pulse test

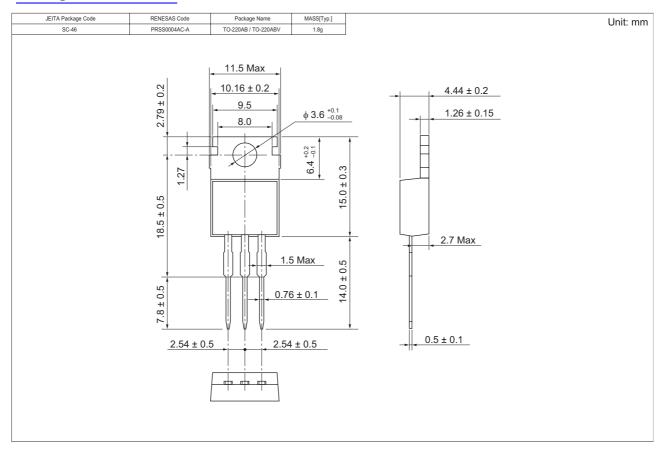
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Package Dimenstons



Ordering Information

Part Name	Quantity	Shipping Container
2SK1338-E	500 pcs	Box (Sack)

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